

Global IC Package Substrate Market Research Report 2017

<https://marketpublishers.com/r/G21696C1B7CEN.html>

Date: February 2017

Pages: 123

Price: US\$ 2,900.00 (Single User License)

ID: G21696C1B7CEN

Abstracts

Notes:

Production, means the output of IC Package Substrate

Revenue, means the sales value of IC Package Substrate

This report studies IC Package Substrate in Global market, especially in North America, Europe, China, Japan, Southeast Asia and India, focuses on top manufacturers in global market, with capacity, production, price, revenue and market share for each manufacturer, covering

Honeywell ACI

IBM

Unimicron

Multek

AT&S

Aspocomp

JCI(MGC)

Hitachi?Cable

Ibiden

Samsung

Shinko

Market Segment by Regions, this report splits Global into several key Regions, with production, consumption, revenue, market share and growth rate of IC Package Substrate in these regions, from 2011 to 2021 (forecast), like

North America

Europe

China

Japan

Southeast Asia

India

Split by product type, with production, revenue, price, market share and growth rate of each type, can be divided into

Ball Grid Array(BGA)

Chip Scale Package/Chip Size Package(CSP)

Flip Chip(FC)

Split by application, this report focuses on consumption, market share and growth rate of IC Package Substrate in each application, can be divided into

Mobile Telephone

PC

Camera

Others

Contents

Global IC Package Substrate Market Research Report 2017

1 IC PACKAGE SUBSTRATE MARKET OVERVIEW

- 1.1 Product Overview and Scope of IC Package Substrate
- 1.2 IC Package Substrate Segment by Type
 - 1.2.1 Global Production Market Share of IC Package Substrate by Type in 2015
 - 1.2.2 Ball Grid Array(BGA)
 - 1.2.3 Chip Scale Package/Chip Size Package(CSP)
 - 1.2.4 Flip Chip(FC)
- 1.3 IC Package Substrate Segment by Application
 - 1.3.1 IC Package Substrate Consumption Market Share by Application in 2015
 - 1.3.2 Mobile Telephone
 - 1.3.3 PC
 - 1.3.4 Camera
 - 1.3.5 Others
- 1.4 IC Package Substrate Market by Region
 - 1.4.1 North America Status and Prospect (2012-2022)
 - 1.4.2 Europe Status and Prospect (2012-2022)
 - 1.4.3 China Status and Prospect (2012-2022)
 - 1.4.4 Japan Status and Prospect (2012-2022)
 - 1.4.5 Southeast Asia Status and Prospect (2012-2022)
 - 1.4.6 India Status and Prospect (2012-2022)
- 1.5 Global Market Size (Value) of IC Package Substrate (2012-2022)

2 GLOBAL IC PACKAGE SUBSTRATE MARKET COMPETITION BY MANUFACTURERS

- 2.1 Global IC Package Substrate Production and Share by Manufacturers (2015 and 2016)
- 2.2 Global IC Package Substrate Revenue and Share by Manufacturers (2015 and 2016)
- 2.3 Global IC Package Substrate Average Price by Manufacturers (2015 and 2016)
- 2.4 Manufacturers IC Package Substrate Manufacturing Base Distribution, Sales Area and Product Type
- 2.5 IC Package Substrate Market Competitive Situation and Trends
 - 2.5.1 IC Package Substrate Market Concentration Rate

2.5.2 IC Package Substrate Market Share of Top 3 and Top 5 Manufacturers

2.5.3 Mergers & Acquisitions, Expansion

3 GLOBAL IC PACKAGE SUBSTRATE PRODUCTION, REVENUE (VALUE) BY REGION (2012-2017)

3.1 Global IC Package Substrate Production by Region (2012-2017)

3.2 Global IC Package Substrate Production Market Share by Region (2012-2017)

3.3 Global IC Package Substrate Revenue (Value) and Market Share by Region (2012-2017)

3.4 Global IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

3.5 North America IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

3.6 Europe IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

3.7 China IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

3.8 Japan IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

3.9 Southeast Asia IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

3.10 India IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

4 GLOBAL IC PACKAGE SUBSTRATE SUPPLY (PRODUCTION), CONSUMPTION, EXPORT, IMPORT BY REGIONS (2012-2017)

4.1 Global IC Package Substrate Consumption by Regions (2012-2017)

4.2 North America IC Package Substrate Production, Consumption, Export, Import (2012-2017)

4.3 Europe IC Package Substrate Production, Consumption, Export, Import (2012-2017)

4.4 China IC Package Substrate Production, Consumption, Export, Import (2012-2017)

4.5 Japan IC Package Substrate Production, Consumption, Export, Import (2012-2017)

4.6 Southeast Asia IC Package Substrate Production, Consumption, Export, Import (2012-2017)

4.7 India IC Package Substrate Production, Consumption, Export, Import (2012-2017)

5 GLOBAL IC PACKAGE SUBSTRATE PRODUCTION, REVENUE (VALUE), PRICE

TREND BY TYPE

- 5.1 Global IC Package Substrate Production and Market Share by Type (2012-2017)
- 5.2 Global IC Package Substrate Revenue and Market Share by Type (2012-2017)
- 5.3 Global IC Package Substrate Price by Type (2012-2017)
- 5.4 Global IC Package Substrate Production Growth by Type (2012-2017)

6 GLOBAL IC PACKAGE SUBSTRATE MARKET ANALYSIS BY APPLICATION

- 6.1 Global IC Package Substrate Consumption and Market Share by Application (2012-2017)
- 6.2 Global IC Package Substrate Consumption Growth Rate by Application (2012-2017)
- 6.3 Market Drivers and Opportunities
 - 6.3.1 Potential Applications
 - 6.3.2 Emerging Markets/Countries

7 GLOBAL IC PACKAGE SUBSTRATE MANUFACTURERS PROFILES/ANALYSIS

- 7.1 Honeywell ACI
 - 7.1.1 Company Basic Information, Manufacturing Base and Its Competitors
 - 7.1.2 IC Package Substrate Product Type, Application and Specification
 - 7.1.2.1 Ball Grid Array(BGA)
 - 7.1.2.2 Chip Scale Package/Chip Size Package(CSP)
 - 7.1.3 Honeywell ACI IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)
 - 7.1.4 Main Business/Business Overview
- 7.2 IBM
 - 7.2.1 Company Basic Information, Manufacturing Base and Its Competitors
 - 7.2.2 IC Package Substrate Product Type, Application and Specification
 - 7.2.2.1 Ball Grid Array(BGA)
 - 7.2.2.2 Chip Scale Package/Chip Size Package(CSP)
 - 7.2.3 IBM IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)
 - 7.2.4 Main Business/Business Overview
- 7.3 Unimicron
 - 7.3.1 Company Basic Information, Manufacturing Base and Its Competitors
 - 7.3.2 IC Package Substrate Product Type, Application and Specification
 - 7.3.2.1 Ball Grid Array(BGA)
 - 7.3.2.2 Chip Scale Package/Chip Size Package(CSP)

7.3.3 Unimicron IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

7.3.4 Main Business/Business Overview

7.4 Multek

7.4.1 Company Basic Information, Manufacturing Base and Its Competitors

7.4.2 IC Package Substrate Product Type, Application and Specification

7.4.2.1 Ball Grid Array(BGA)

7.4.2.2 Chip Scale Package/Chip Size Package(CSP)

7.4.3 Multek IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

7.4.4 Main Business/Business Overview

7.5 AT&S

7.5.1 Company Basic Information, Manufacturing Base and Its Competitors

7.5.2 IC Package Substrate Product Type, Application and Specification

7.5.2.1 Ball Grid Array(BGA)

7.5.2.2 Chip Scale Package/Chip Size Package(CSP)

7.5.3 AT&S IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

7.5.4 Main Business/Business Overview

7.6 Aspocomp

7.6.1 Company Basic Information, Manufacturing Base and Its Competitors

7.6.2 IC Package Substrate Product Type, Application and Specification

7.6.2.1 Ball Grid Array(BGA)

7.6.2.2 Chip Scale Package/Chip Size Package(CSP)

7.6.3 Aspocomp IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

7.6.4 Main Business/Business Overview

7.7 JCI(MGC)

7.7.1 Company Basic Information, Manufacturing Base and Its Competitors

7.7.2 IC Package Substrate Product Type, Application and Specification

7.7.2.1 Ball Grid Array(BGA)

7.7.2.2 Chip Scale Package/Chip Size Package(CSP)

7.7.3 JCI(MGC) IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

7.7.4 Main Business/Business Overview

7.8 Hitachi?Cable

7.8.1 Company Basic Information, Manufacturing Base and Its Competitors

7.8.2 IC Package Substrate Product Type, Application and Specification

7.8.2.1 Ball Grid Array(BGA)

- 7.8.2.2 Chip Scale Package/Chip Size Package(CSP)
- 7.8.3 Hitachi?Cable IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)
- 7.8.4 Main Business/Business Overview
- 7.9 Ibdien
 - 7.9.1 Company Basic Information, Manufacturing Base and Its Competitors
 - 7.9.2 IC Package Substrate Product Type, Application and Specification
 - 7.9.2.1 Ball Grid Array(BGA)
 - 7.9.2.2 Chip Scale Package/Chip Size Package(CSP)
 - 7.9.3 Ibdien IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)
 - 7.9.4 Main Business/Business Overview
- 7.10 Samsung
 - 7.10.1 Company Basic Information, Manufacturing Base and Its Competitors
 - 7.10.2 IC Package Substrate Product Type, Application and Specification
 - 7.10.2.1 Ball Grid Array(BGA)
 - 7.10.2.2 Chip Scale Package/Chip Size Package(CSP)
 - 7.10.3 Samsung IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)
 - 7.10.4 Main Business/Business Overview
- 7.11 Shinko

8 IC PACKAGE SUBSTRATE MANUFACTURING COST ANALYSIS

- 8.1 IC Package Substrate Key Raw Materials Analysis
 - 8.1.1 Key Raw Materials
 - 8.1.2 Price Trend of Key Raw Materials
 - 8.1.3 Key Suppliers of Raw Materials
 - 8.1.4 Market Concentration Rate of Raw Materials
- 8.2 Proportion of Manufacturing Cost Structure
 - 8.2.1 Raw Materials
 - 8.2.2 Labor Cost
 - 8.2.3 Manufacturing Expenses
- 8.3 Manufacturing Process Analysis of IC Package Substrate

9 INDUSTRIAL CHAIN, SOURCING STRATEGY AND DOWNSTREAM BUYERS

- 9.1 IC Package Substrate Industrial Chain Analysis
- 9.2 Upstream Raw Materials Sourcing

9.3 Raw Materials Sources of IC Package Substrate Major Manufacturers in 2015

9.4 Downstream Buyers

10 MARKETING STRATEGY ANALYSIS, DISTRIBUTORS/TRADERS

10.1 Marketing Channel

10.1.1 Direct Marketing

10.1.2 Indirect Marketing

10.1.3 Marketing Channel Development Trend

10.2 Market Positioning

10.2.1 Pricing Strategy

10.2.2 Brand Strategy

10.2.3 Target Client

10.3 Distributors/Traders List

11 MARKET EFFECT FACTORS ANALYSIS

11.1 Technology Progress/Risk

11.1.1 Substitutes Threat

11.1.2 Technology Progress in Related Industry

11.2 Consumer Needs/Customer Preference Change

11.3 Economic/Political Environmental Change

12 GLOBAL IC PACKAGE SUBSTRATE MARKET FORECAST (2017-2022)

12.1 Global IC Package Substrate Production, Revenue and Price Forecast (2017-2022)

12.1.1 Global IC Package Substrate Production and Growth Rate Forecast (2017-2022)

12.1.2 Global IC Package Substrate Revenue and Growth Rate Forecast (2017-2022)

12.1.3 Global IC Package Substrate Price and Trend Forecast (2017-2022)

12.2 Global IC Package Substrate Production, Consumption, Import and Export Forecast by Regions (2017-2022)

12.2.1 North America IC Package Substrate Production, Revenue, Consumption, Export and Import Forecast (2017-2022)

12.2.2 Europe IC Package Substrate Production, Revenue, Consumption, Export and Import Forecast (2017-2022)

12.2.3 China IC Package Substrate Production, Revenue, Consumption, Export and Import Forecast (2017-2022)

12.2.4 Japan IC Package Substrate Production, Revenue, Consumption, Export and Import Forecast (2017-2022)

12.2.5 Southeast Asia IC Package Substrate Production, Revenue, Consumption, Export and Import Forecast (2017-2022)

12.2.6 India IC Package Substrate Production, Revenue, Consumption, Export and Import Forecast (2017-2022)

12.3 Global IC Package Substrate Production, Revenue and Price Forecast by Type (2017-2022)

12.4 Global IC Package Substrate Consumption Forecast by Application (2017-2022)

13 RESEARCH FINDINGS AND CONCLUSION

14 APPENDIX

Methodology

Analyst Introduction

Data Source

The report requires updating with new data and is sent in 2-3 business days after order is placed.

List Of Tables

LIST OF TABLES AND FIGURES

Figure Picture of IC Package Substrate

Figure Global Production Market Share of IC Package Substrate by Type in 2015

Figure Product Picture of Ball Grid Array(BGA)

Table Major Manufacturers of Ball Grid Array(BGA)

Figure Product Picture of Chip Scale Package/Chip Size Package(CSP)

Table Major Manufacturers of Chip Scale Package/Chip Size Package(CSP)

Figure Product Picture of Flip Chip(FC)

Table Major Manufacturers of Flip Chip(FC)

Table IC Package Substrate Consumption Market Share by Application in 2015

Figure Mobile Telephone Examples

Figure PC Examples

Figure Camera Examples

Figure Others Examples

Figure North America IC Package Substrate Revenue (Million USD) and Growth Rate (2012-2022)

Figure Europe IC Package Substrate Revenue (Million USD) and Growth Rate (2012-2022)

Figure China IC Package Substrate Revenue (Million USD) and Growth Rate (2012-2022)

Figure Japan IC Package Substrate Revenue (Million USD) and Growth Rate (2012-2022)

Figure Southeast Asia IC Package Substrate Revenue (Million USD) and Growth Rate (2012-2022)

Figure India IC Package Substrate Revenue (Million USD) and Growth Rate (2012-2022)

Figure Global IC Package Substrate Revenue (Million UDS) and Growth Rate (2012-2022)

Table Global IC Package Substrate Capacity of Key Manufacturers (2015 and 2016)

Table Global IC Package Substrate Capacity Market Share by Manufacturers (2015 and 2016)

Figure Global IC Package Substrate Capacity of Key Manufacturers in 2015

Figure Global IC Package Substrate Capacity of Key Manufacturers in 2016

Table Global IC Package Substrate Production of Key Manufacturers (2015 and 2016)

Table Global IC Package Substrate Production Share by Manufacturers (2015 and 2016)

Figure 2015 IC Package Substrate Production Share by Manufacturers

Figure 2016 IC Package Substrate Production Share by Manufacturers

Table Global IC Package Substrate Revenue (Million USD) by Manufacturers (2015 and 2016)

Table Global IC Package Substrate Revenue Share by Manufacturers (2015 and 2016)

Table 2015 Global IC Package Substrate Revenue Share by Manufacturers

Table 2016 Global IC Package Substrate Revenue Share by Manufacturers

Table Global Market IC Package Substrate Average Price of Key Manufacturers (2015 and 2016)

Figure Global Market IC Package Substrate Average Price of Key Manufacturers in 2015

Table Manufacturers IC Package Substrate Manufacturing Base Distribution and Sales Area

Table Manufacturers IC Package Substrate Product Type

Figure IC Package Substrate Market Share of Top 3 Manufacturers

Figure IC Package Substrate Market Share of Top 5 Manufacturers

Table Global IC Package Substrate Capacity by Regions (2012-2017)

Figure Global IC Package Substrate Capacity Market Share by Regions (2012-2017)

Figure Global IC Package Substrate Capacity Market Share by Regions (2012-2017)

Figure 2015 Global IC Package Substrate Capacity Market Share by Regions

Table Global IC Package Substrate Production by Regions (2012-2017)

Figure Global IC Package Substrate Production and Market Share by Regions (2012-2017)

Figure Global IC Package Substrate Production Market Share by Regions (2012-2017)

Figure 2015 Global IC Package Substrate Production Market Share by Regions

Table Global IC Package Substrate Revenue by Regions (2012-2017)

Table Global IC Package Substrate Revenue Market Share by Regions (2012-2017)

Table 2015 Global IC Package Substrate Revenue Market Share by Regions

Table Global IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

Table North America IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

Table Europe IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

Table China IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

Table Japan IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

Table Southeast Asia IC Package Substrate Production, Revenue, Price and Gross

Margin (2012-2017)

Table India IC Package Substrate Production, Revenue, Price and Gross Margin (2012-2017)

Table Global IC Package Substrate Consumption Market by Regions (2012-2017)

Table Global IC Package Substrate Consumption Market Share by Regions (2012-2017)

Figure Global IC Package Substrate Consumption Market Share by Regions (2012-2017)

Figure 2015 Global IC Package Substrate Consumption Market Share by Regions

Table North America IC Package Substrate Production, Consumption, Import & Export (2012-2017)

Table Europe IC Package Substrate Production, Consumption, Import & Export (2012-2017)

Table China IC Package Substrate Production, Consumption, Import & Export (2012-2017)

Table Japan IC Package Substrate Production, Consumption, Import & Export (2012-2017)

Table Southeast Asia IC Package Substrate Production, Consumption, Import & Export (2012-2017)

Table India IC Package Substrate Production, Consumption, Import & Export (2012-2017)

Table Global IC Package Substrate Production by Type (2012-2017)

Table Global IC Package Substrate Production Share by Type (2012-2017)

Figure Production Market Share of IC Package Substrate by Type (2012-2017)

Figure 2015 Production Market Share of IC Package Substrate by Type

Table Global IC Package Substrate Revenue by Type (2012-2017)

Table Global IC Package Substrate Revenue Share by Type (2012-2017)

Figure Production Revenue Share of IC Package Substrate by Type (2012-2017)

Figure 2015 Revenue Market Share of IC Package Substrate by Type

Table Global IC Package Substrate Price by Type (2012-2017)

Figure Global IC Package Substrate Production Growth by Type (2012-2017)

Table Global IC Package Substrate Consumption by Application (2012-2017)

Table Global IC Package Substrate Consumption Market Share by Application (2012-2017)

Figure Global IC Package Substrate Consumption Market Share by Application in 2015

Table Global IC Package Substrate Consumption Growth Rate by Application (2012-2017)

Figure Global IC Package Substrate Consumption Growth Rate by Application (2012-2017)

Table Honeywell ACI Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Honeywell ACI IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure Honeywell ACI IC Package Substrate Market Share (2015 and 2016)

Table IBM Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table IBM IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure IBM IC Package Substrate Market Share (2015 and 2016)

Table Unimicron Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Unimicron IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure Unimicron IC Package Substrate Market Share (2015 and 2016)

Table Multek Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Multek IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure Multek IC Package Substrate Market Share (2015 and 2016)

Table AT&S Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table AT&S IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure AT&S IC Package Substrate Market Share (2015 and 2016)

Table Aspocomp Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Aspocomp IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure Aspocomp IC Package Substrate Market Share (2015 and 2016)

Table JCI(MGC) Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table JCI(MGC) IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure JCI(MGC) IC Package Substrate Market Share (2015 and 2016)

Table Hitachi?Cable Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Hitachi?Cable IC Package Substrate Production, Revenue, Price and Gross Margin (2015 and 2016)

Figure Hitachi?Cable IC Package Substrate Market Share (2015 and 2016)

Table Ibiden Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Ibiden IC Package Substrate Production, Revenue, Price and Gross Margin

(2015 and 2016)

Figure Ibiden IC Package Substrate Market Share (2015 and 2016)

Table Samsung Basic Information, Manufacturing Base, Sales Area and Its Competitors

Table Samsung IC Package Substrate Production, Revenue, Price and Gross Margin
(2015 and 2016)

Figure Samsung IC Package Substrate Market Share (2015 and 2016)

Table Production Base and Market Concentration Rate of Raw Material

Figure Price Trend of Key Raw Materials

Table Key Suppliers of Raw Materials

Figure Manufacturing Cost Structure of IC Package Substrate

Figure Manufacturing Process Analysis of IC Package Substrate

Figure IC Package Substrate Industrial Chain Analysis

Table Raw Materials Sources of IC Package Substrate Major Manufacturers in 2015

Table Major Buyers of IC Package Substrate

Table Distributors/Traders List

Figure Global IC Package Substrate Production and Growth Rate Forecast (2017-2022)

Figure Global IC Package Substrate Revenue and Growth Rate Forecast (2017-2022)

Figure Global IC Package Substrate Price and Trend Forecast (2017-2022)

Table Global IC Package Substrate Production Forecast by Regions (2017-2022)

Table Global IC Package Substrate Consumption Forecast by Regions (2017-2022)

Figure North America IC Package Substrate Production, Revenue and Growth Rate
Forecast (2017-2022)

Table North America IC Package Substrate Production, Consumption, Export and
Import Forecast (2017-2022)

Figure Europe IC Package Substrate Production, Revenue and Growth Rate Forecast
(2017-2022)

Table Europe IC Package Substrate Production, Consumption, Export and Import
Forecast (2017-2022)

Figure China IC Package Substrate Production, Revenue and Growth Rate Forecast
(2017-2022)

Table China IC Package Substrate Production, Consumption, Export and Import
Forecast (2017-2022)

Figure Japan IC Package Substrate Production, Revenue and Growth Rate Forecast
(2017-2022)

Table Japan IC Package Substrate Production, Consumption, Export and Import
Forecast (2017-2022)

Figure Southeast Asia IC Package Substrate Production, Revenue and Growth Rate
Forecast (2017-2022)

Table Southeast Asia IC Package Substrate Production, Consumption, Export and

Import Forecast (2017-2022)

Figure India IC Package Substrate Production, Revenue and Growth Rate Forecast (2017-2022)

Table India IC Package Substrate Production, Consumption, Export and Import Forecast (2017-2022)

Table Global IC Package Substrate Production Forecast by Type (2017-2022)

Table Global IC Package Substrate Revenue Forecast by Type (2017-2022)

Table Global IC Package Substrate Price Forecast by Type (2017-2022)

Table Global IC Package Substrate Consumption Forecast by Application (2017-2022)

I would like to order

Product name: Global IC Package Substrate Market Research Report 2017

Product link: <https://marketpublishers.com/r/G21696C1B7CEN.html>

Price: US\$ 2,900.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/G21696C1B7CEN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:
Last name:
Email:
Company:
Address:
City:
Zip code:
Country:
Tel:
Fax:
Your message:

****All fields are required**

Customer signature _____

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970